

**APPLICATION DATA SHEET****Application Information**

Application Number::

Filing Date:: October 17, 2005

Application Type:: Regular

Subject Matter:: Utility

Suggested Classification::

Suggested Group Art Unit::

CD-ROM or CD-R:: None

Number of CD Disks::

Number of Copies of CDs::

Sequence Submission?:: No

Computer Readable Form (CRF)?:: No

Number of Copies of CRF::

Title : MONITORING THE REDUCTION IN  
THICKNESS AS MATERIAL IS REMOVED  
FROM A WAFER COMPOSITE AND TEST  
STRUCTURE FOR MONITORING REMOVAL  
OF MATERIAL

Attorney Docket Number:: 60291.000041

Request for Early Publication?:: No

Request for Non-Publication?:: No

Suggested Drawing Figure:: 1

Total Drawing Sheets:: 1

Small Entity?:: No

Latin name::

Variety denomination name::

Petition Included?:: No

Petition Type::

Licensed US Government Agency::

Contract or Grant Numbers::

Secrecy Order in Parent Application?:: No

### **Applicant Information**

Applicant One Authority Type:: Inventor  
Primary Citizenship Germany  
Country::  
Status:: Full Capacity

Applicant One Given Name:: Ralf  
Middle Name::  
Family Name:: LERNER  
Name Suffix::  
City of Residence:: Erfurt  
State or Province of Residence::  
Country of Residence:: Germany  
Street of Mailing Address:: Josef-Albers-Strasse 20  
City of Mailing Address:: Erfurt  
State or Province of Mailing Address::  
Country of Mailing Address:: Germany  
Postal or Zip Code of Mailing Address:: 99085

### **Correspondence Information**

Correspondence Customer No.:: 21967  
Name:: Hunton & Williams LLP  
Street of Mailing Address:: 1900 K Street, N.W.  
City of Mailing Address: Washington, DC  
State or Province of Mailing Address::  
Country of Mailing Address:: USA  
Postal or Zip Code of Mailing Address 20006-1109  
Phone Number:: 202-955-1500  
Fax Number:: 202-778-2201  
E-Mail Address:: cli@hunton.com

**Representative Information**

Representative Customer Number:: 21967

**International Priority Information**

Application::	Continuity Type::	Parent Application::	Parent Filing Date::
This Application	Claims priority to	PCT/DE2004/000801	16 April 2004

**Foreign Priority Information**

Country:	Application Number::	Filing Date::	Priority Claimed::
Germany	103 17 747.7	17 April 2003	Yes

**Assignee Information**

Assignee Name:: X-FAB SEMICONDUCTOR FOUNDRIES AG.  
Street of Mailing Address :: Haarbergstrasse 67  
City of Mailing Address:: Erfurt  
State of Province of Mailing Address::  
Country of Mailing Address:: Germany  
Postal or Zip Code of Mailing Address:: 99085